

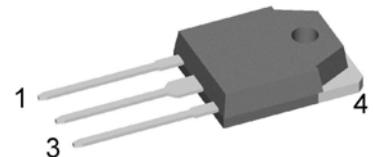
Schottky Diode Gen 2

V_{RRM} = 150V
 I_{FAV} = 2x 60A
 V_F = 0.8V

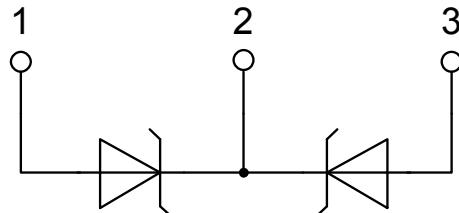
High Performance Schottky Diode
Low Loss and Soft Recovery
Common Cathode

Part number

DSA120C150QB



Backside: cathode



Features / Advantages:

- Very low V_F
- Extremely low switching losses
- Low I_{rm} values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Package: TO-3P

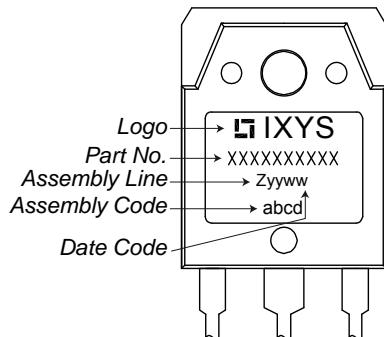
- Industry standard outline compatible with TO-247
- RoHS compliant
- Epoxy meets UL 94V-0

Schottky

| Symbol | Definition | Conditions | Ratings | | | |
|-------------------|--|--|---|------|------------------------------|----------------|
| | | | min. | typ. | max. | |
| V_{RSM} | max. non-repetitive reverse blocking voltage | $T_{VJ} = 25^\circ C$ | | | 150 | V |
| V_{RRM} | max. repetitive reverse blocking voltage | $T_{VJ} = 25^\circ C$ | | | 150 | V |
| I_R | reverse current, drain current | $V_R = 150 V$ $V_R = 150 V$ | $T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$ | | 900 5 | μA mA |
| V_F | forward voltage drop | $I_F = 60 A$ $I_F = 120 A$ $I_F = 60 A$ $I_F = 120 A$ | $T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$ | | 0.93 1.13 0.80 1.03 | V V |
| I_{FAV} | average forward current | $T_C = 150^\circ C$ rectangular | $T_{VJ} = 175^\circ C$ | | 60 | A |
| $I_F = 0.5$ | | | | | | |
| V_{F0} r_F | threshold voltage slope resistance } for power loss calculation only | | $T_{VJ} = 175^\circ C$ | | 0.51 3.9 | V $m\Omega$ |
| R_{thJC} | thermal resistance junction to case | | | | 0.4 | K/W |
| R_{thCH} | thermal resistance case to heatsink | | | 0.25 | | K/W |
| P_{tot} | total power dissipation | $T_C = 25^\circ C$ | | | 375 | W |
| I_{FSM} | max. forward surge current | $t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}; V_R = 0 V$ | $T_{VJ} = 45^\circ C$ | | 1.20 | kA |
| C_J | junction capacitance | $V_R = 24 V$ f = 1 MHz | $T_{VJ} = 25^\circ C$ | | 481 | pF |

| Package TO-3P | | | Ratings | | |
|---------------|------------------------------|----------------------------|---------|------|--------|
| Symbol | Definition | Conditions | min. | typ. | max. |
| I_{RMS} | RMS current | per terminal ¹⁾ | | | 70 A |
| T_{VJ} | virtual junction temperature | | -55 | | 175 °C |
| T_{op} | operation temperature | | -55 | | 150 °C |
| T_{stg} | storage temperature | | -55 | | 150 °C |
| Weight | | | | 5 | g |
| M_D | mounting torque | | 0.8 | | 1.2 Nm |
| F_c | mounting force with clip | | 20 | | 120 N |

Product Marking



Part number

D = Diode
 S = Schottky Diode
 A = low VF
 120 = Current Rating [A]
 C = Common Cathode
 150 = Reverse Voltage [V]
 QB = TO-3P (3)

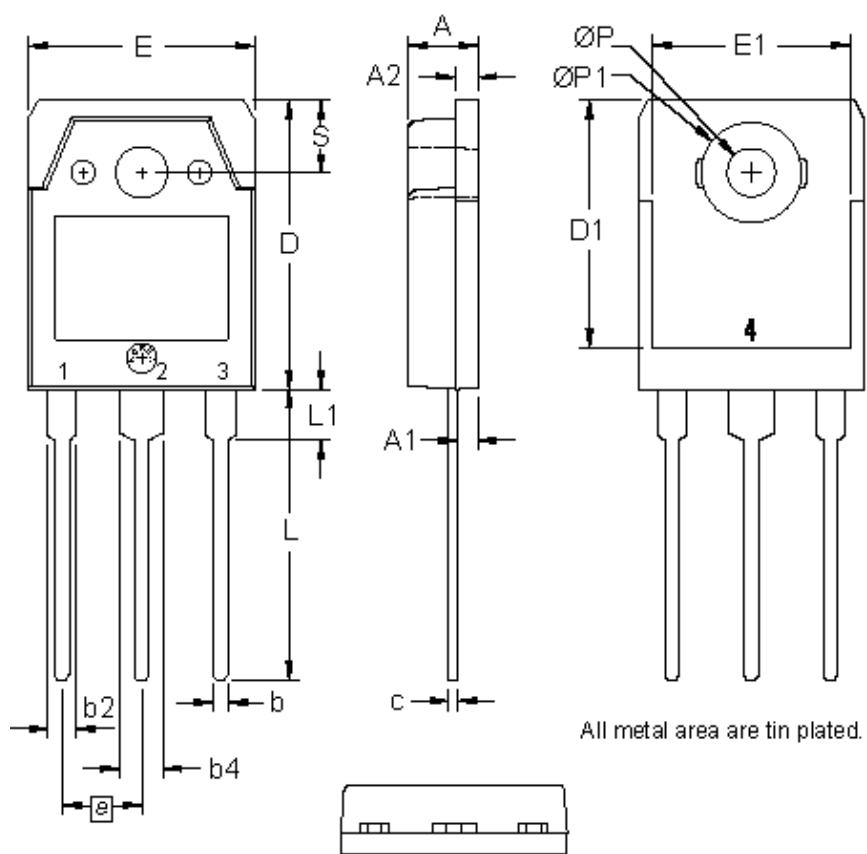
| Ordering | Part Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|--------------|--------------------|---------------|----------|----------|
| Standard | DSA120C150QB | DSA120C150QB | Tube | 30 | 501788 |

Equivalent Circuits for Simulation

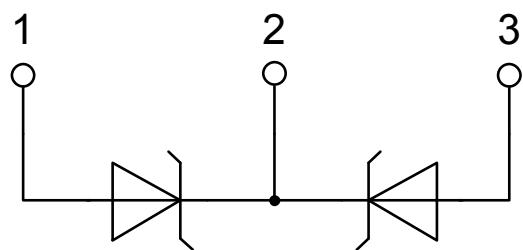
^{*} on die level $T_{VJ} = 175 \text{ }^{\circ}\text{C}$

| | | | | |
|-------------|--------------------|-------|----------|------------------|
| | V_0 | R_0 | Schottky | |
| $V_{0\max}$ | threshold voltage | 0.51 | | V |
| $R_{0\max}$ | slope resistance * | 1.3 | | $\text{m}\Omega$ |

Outlines TO-3P



| Dim. | Millimeter | | Inches | |
|------|------------|-------|--------|-------|
| | min | max | min | max |
| A | 4.70 | 4.90 | 0.185 | 0.193 |
| A1 | 1.30 | 1.50 | 0.051 | 0.059 |
| A2 | 1.45 | 1.65 | 0.057 | 0.065 |
| b | 0.90 | 1.15 | 0.035 | 0.045 |
| b2 | 1.90 | 2.20 | 0.075 | 0.087 |
| b4 | 2.90 | 3.20 | 0.114 | 0.126 |
| c | 0.55 | 0.80 | 0.022 | 0.031 |
| D | 19.80 | 20.10 | 0.780 | 0.791 |
| D1 | 16.90 | 17.20 | 0.665 | 0.677 |
| E | 15.50 | 15.80 | 0.610 | 0.622 |
| E1 | 13.50 | 13.70 | 0.531 | 0.539 |
| e | 5.45 | BSC | 0.215 | BSC |
| L | 19.80 | 20.20 | 0.780 | 0.795 |
| L1 | 3.40 | 3.60 | 0.134 | 0.142 |
| ØP | 3.20 | 3.40 | 0.126 | 0.134 |
| ØP1 | 6.90 | 7.10 | 0.272 | 0.280 |
| S | 4.90 | 5.10 | 0.193 | 0.201 |



Schottky

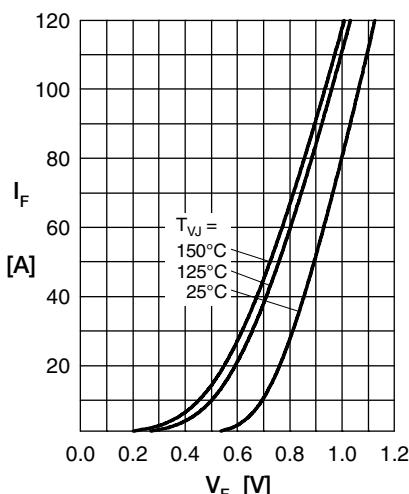


Fig. 1 Max. forward voltage drop characteristics

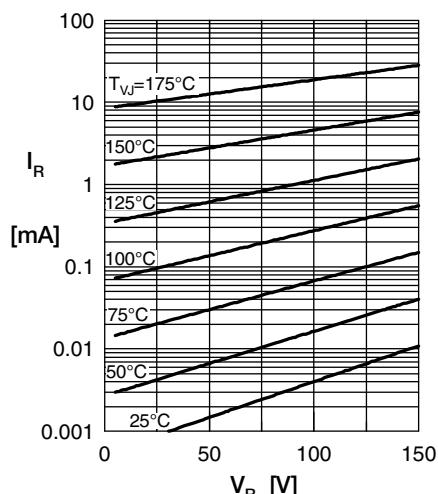
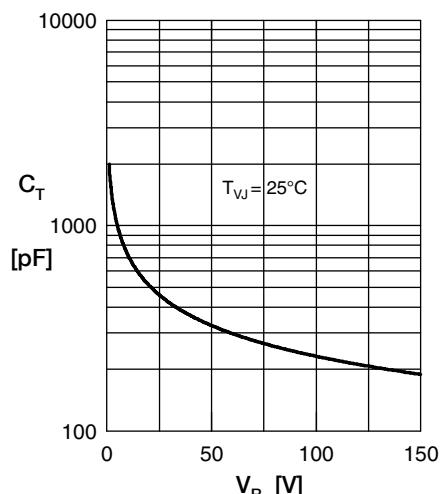
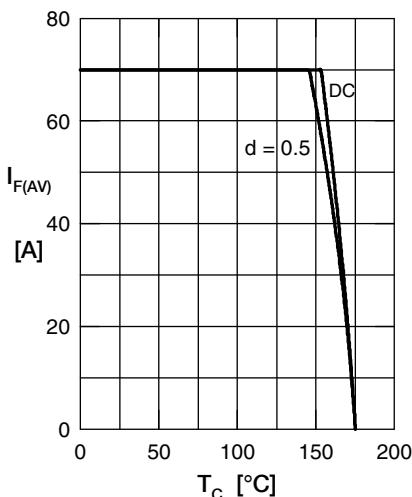
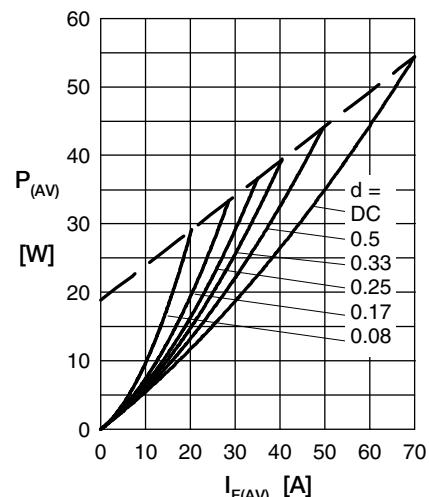
Fig. 2 Typ. reverse current I_R vs. reverse voltage V_R Fig. 3 Typ. junction capacitance C_T vs. reverse voltage V_R Fig. 4 Average forward current $I_{F(AV)}$ vs. case temp T_C 

Fig. 5 Forward power loss characteristics

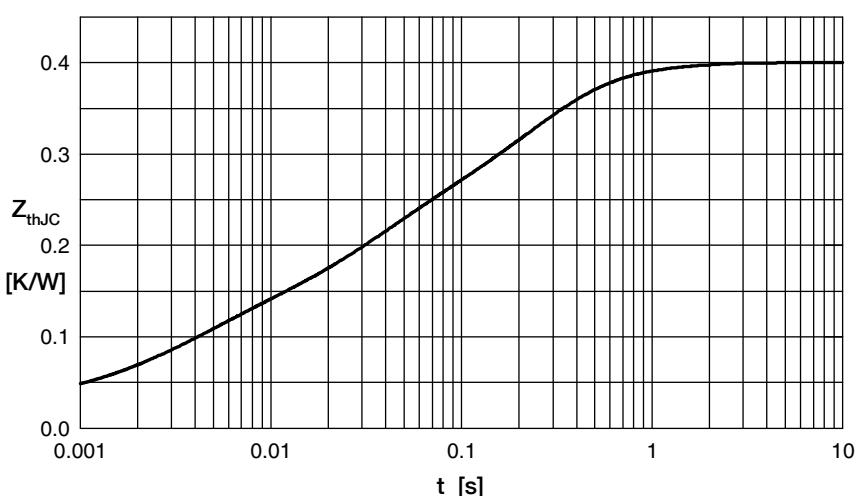


Fig. 6 Transient thermal impedance junction to case at various duty cycles

| R_{thi} | t_i |
|-----------|--------|
| 0.022 | 0.0002 |
| 0.082 | 0.0032 |
| 0.104 | 0.026 |
| 0.165 | 0.208 |
| 0.027 | 0.79 |

Note: All curves are per diode